onsemi

MOSFET – Power, Single N-Channel

40 V, 237 A, 1.2 m Ω

NTMJS1D2N04CL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- LFPAK8 Package, Industry Standard
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Symbol	Parar	Value	Unit		
V _{DSS}	Drain-to-Source Voltag	40	V		
V _{GS}	Gate-to-Source Voltage	Э		±20	V
Ι _D			$T_{C} = 25^{\circ}C$	237	А
	Current R _{θJC} (Notes 1, 3)	Steady	T _C = 100°C	168	
PD	Power Dissipation	State	$T_{C} = 25^{\circ}C$	128	W
	R _{θJC} (Note 1)		$T_{C} = 100^{\circ}C$	64	
Ι _D	Continuous Drain		T _A = 25°C	41	А
	Current R _{θJA} (Notes 1, 2, 3)	Steady	T _A = 100°C	29	
PD	Power Dissipation	State	T _A = 25°C	3.8	W
	R _{θJA} (Notes 1, 2)		$T_A = 100^{\circ}C$	1.9	
I _{DM}	Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	1480	А
T _J , T _{stg}	Operating Junction and Range	–55 to + 175	°C		
۱ _S	Source Current (Body D	107	А		
E _{AS}	Single Pulse Drain-to-S Energy (I _{L(pk)} = 19 A)	453	mJ		
TL	Lead Temperature for S (1/8" from case for 10 s	0	urposes	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$R_{ ext{ heta}JC}$	Junction-to-Case - Steady State		°C/W
$R_{\theta JA}$	Junction-to-Ambient - Steady State (Note 2)	36	

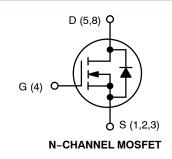
 The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

 Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

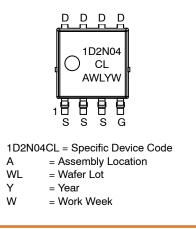
V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
40 V	1.2 m Ω @ 10 V	007 4
	1.8 mΩ @ 4.5 V	237 A



LFPAK8 CASE 760AA



MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Test Cond	Test Condition		Тур	Max	Unit
OFF CHAR	ACTERISTICS						
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	V_{GS} = 0 V, I_D = 250 μ A		40			V
V _{(BR)DSS} / T _J	Drain-to-Source Breakdown Voltage Temperature Coefficient				20		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{GS} = 0 V, V _{DS} = 40 V	$V_{GS} = 0 V,$ $T_{J} = 25^{\circ}C$			10	
		$V_{DS} = 40 \text{ V}$ $T_{J} = 125^{\circ}\text{C}$				250	μΑ
I _{GSS}	Gate-to-Source Leakage Current	$V_{DS} = 0 V, V_{GS} = 20 V$				100	nA
	$\frac{1}{16SS} \qquad \text{Gale-10-Source Leakage Current} \qquad \qquad \text{V}_{DS} = 0 \text{ V}, \text{ V}_{GS} = 20 \text{ V} \qquad \qquad 100 \qquad \text{IA}$						

V _{GS(TH)}	Gate Threshold Voltage	V_{GS} = V_{DS} , I_D = 170 μ A		1.2		2.0	V
$V_{GS(TH)}/T_J$	Threshold Temperature Coefficient				-5.9		mV/°C
R _{DS(on)}	Drain-to-Source On Resistance	V _{GS} = 4.5 V	I _D = 50 A		1.5	1.8	mΩ
R _{DS(on)}	Drain-to-Source On Resistance	V _{GS} = 10 V	I _D = 50 A		1	1.2	mΩ
9fs	Forward Transconductance	V _{DS} = 10 V, I _D = 50 A			190		S

CHARGES, CAPACITANCES & GATE RESISTANCE

C _{ISS}	Input Capacitance		5600	
C _{OSS}	Output Capacitance	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 25 V	2600	pF
C _{RSS}	Reverse Transfer Capacitance		70	
Q _{G(TOT)}	Total Gate Charge	V_{GS} = 4.5 V, V_{DS} = 20 V; I_{D} = 50 A	44	nC
Q _{G(TOT)}	Total Gate Charge	V_{GS} = 10 V, V_{DS} = 20 V; I_{D} = 50 A	93	
Q _{G(TH)}	Threshold Gate Charge		9.4	
Q _{GS}	Gate-to-Source Charge		17.2	nC
Q _{GD}	Gate-to-Drain Charge	V _{GS} = 10 V, V _{DS} = 20 V; I _D = 50 A	13.6	
V _{GP}	Plateau Voltage		3.1	V

SWITCHING CHARACTERISTICS (Note 7)

t _{d(ON)}	Turn-On Delay Time		24	
t _r	Rise Time	V _{GS} = 10 V, V _{DS} = 20 V,	72	
t _{d(OFF)}	Turn-Off Delay Time	$I_D = 50 \text{ A}, \text{ R}_G = 2.5 \Omega$	122	ns
t _f	Fall Time		116	

DRAIN-SOURCE DIODE CHARACTERISTICS

V _{SD}	Forward Diode Voltage	V _{GS} = 0 V, I _S = 50 A	$T_J = 25^{\circ}C$	0.76	1.2	V
			T _J = 125°C	0.66		V
t _{RR}	Reverse Recovery Time	V _{GS} = 0 V, dIS/dt = 100 A/µs, I _S = 50 A		59		
ta	Charge Time			29		ns
t _b	Discharge Time			30		
Q _{RR}	Reverse Recovery Charge			43		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

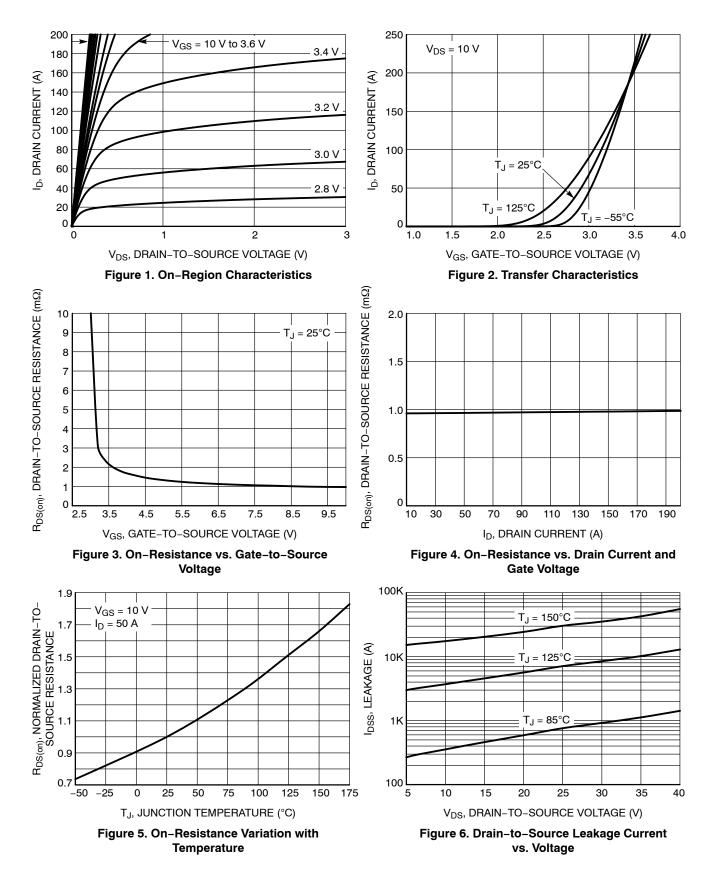
Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

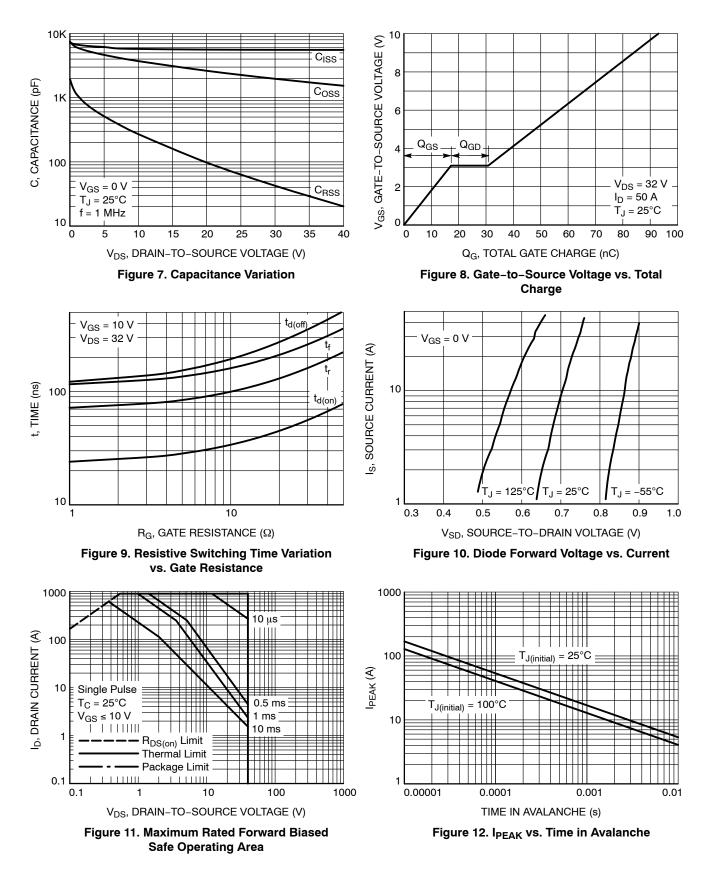
6. Pulse Test: pulse width \leq 300 µs, duty cycle \leq 2%.

7. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (coninued)



TYPICAL CHARACTERISTICS (coninued)

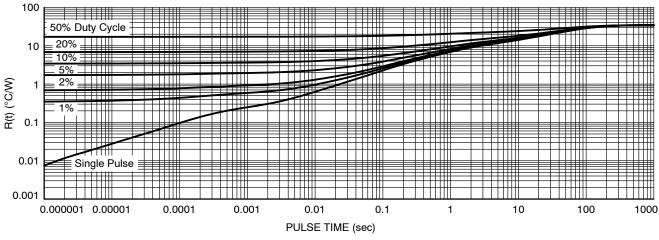


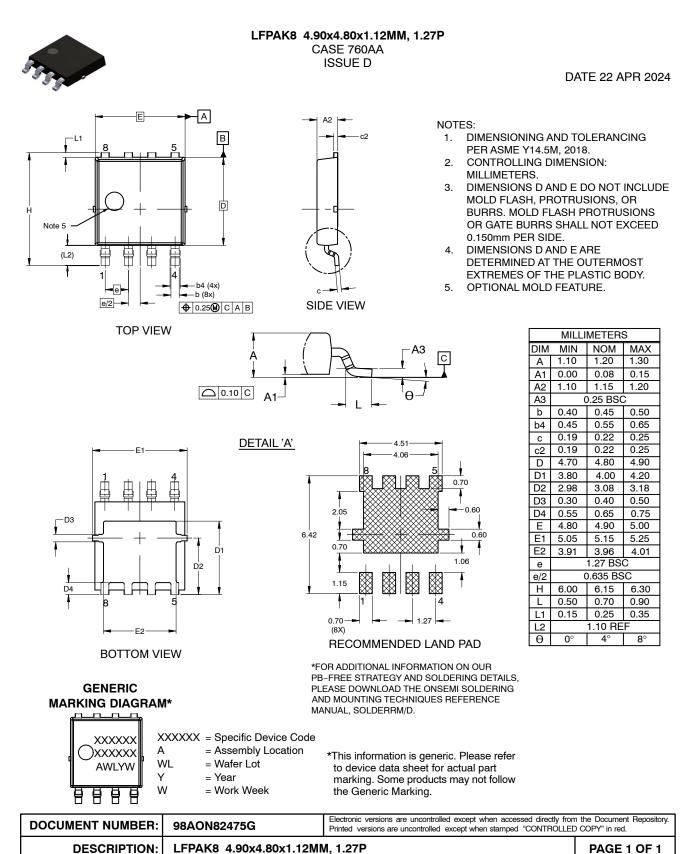
Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTMJS1D2N04CLTWG	1D2N04 CL	LFPAK8 (Pb–Free)	3,000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

onsemi



onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>